March 2015



ON Semiconductor®

FDD5680

N-Channel, PowerTrenchTM MOSFET

General Description

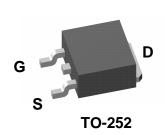
This N-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

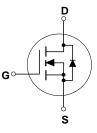
Applications

- DC/DC converter
- Motor drives

Features

- 38 A, 60 V. $R_{DS(on)} = 0.021 \ \Omega \ @ V_{GS} = 10 \ V$ $R_{DS(on)} = 0.025 \ \Omega \ @ V_{GS} = 6 \ V.$
- Low gate charge (33nC typical).
- Fast switching speed.
- High performance trench technology for extremely low R_{DS(on)}.





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±20	V
ID	Maximun Drain Current - Continuous	(Note 1)	38	A
		(Note 1a)	8.5	
	Maximum Drain Current - Pulsed		100	
P _D	Maximum Power Dissipation @ $T_c = 25^{\circ}C$	(Note 1)	60	W
	$T_A = 25^{\circ}C$	(Note 1a)	2.8	
	$T_A = 25^{\circ}C$	(Note 1b)	1.3	
T _J , T _{stg}	Operating and Storage Junction Temperatu	ire Range	-55 to +150	∘C

Thermal Characteristics

R _{θJC}	Thermal Resistance, Junction-to- Case	(Note 1)	2.1	∘C/W
$R_{\Theta^{JA}}$	Thermal Resistance, Junction-to- Ambient	(Note 1b)	96	∘C/W

Package Marking and Ordering InformationDevice MarkingDeviceReel SizeTape widthQuantityFDD5680FDD568013"16mm2500

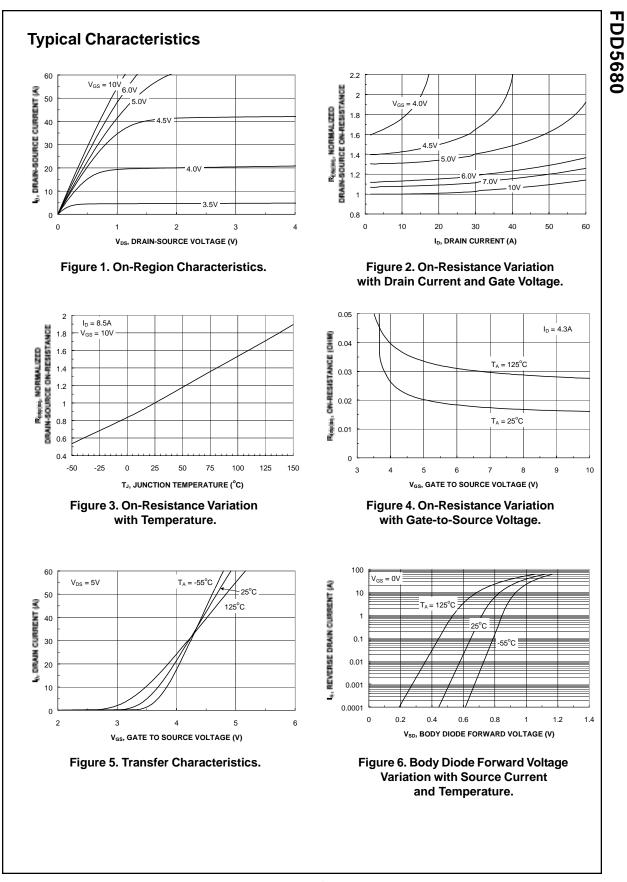
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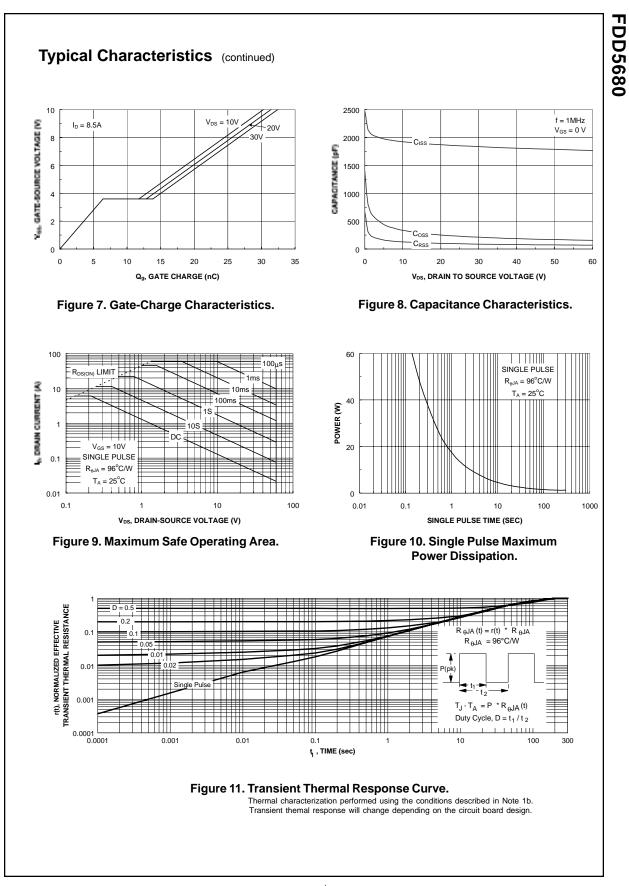
Publication Order Number: FDD5680/D

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics				-	
N _{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 30 \text{ V}, I_{D} = 38 \text{ A}$			140	mJ
AR	Maximum Drain-Source Avalanche	e Current			38	А
3V _{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0~V,~I_{D}=250~\mu A$	60			V
	Breakdown Voltage Temperature Coefficient	$I_D = 250\mu$ A, Referenced to 25° C		60		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}$			1	μд
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 20V, V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	Acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2	2.4	4	V
$\Delta V_{GS(th)}$ ΔT_{I}	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A, Referenced to 25^{\circ}C$		-6.4		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance			0.017 0.028 0.019	0.021 0.042 0.025	Ω
D(on)	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	50			А
JFS	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$		30		S
Ciss Coss Crss	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 30 V, V_{GS} = 0 V,$ f = 1.0 MHz		1835 210 90		pF pF pF
Switchin	g Characteristics (Note 2)					
d(on)	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 1 \text{ A},$		15	27	ns
r	Turn-On Rise Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		9	18	ns
d(off)	Turn-Off Delay Time			35	56	ns
f	Turn-Off Fall Time			16	26	ns
J ^a	Total Gate Charge	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 8.5 \text{ A},$		33	46	nC
2 _{gs}	Gate-Source Charge	V _{GS} = 10 V,		6.5		nC
Q _{gd}	Gate-Drain Charge			7.5		nC
Drain-So	urce Diode Characteristics	and Maximum Ratings				
s	Maximum Continuous Drain-Source	-			2.3	А
/ _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \ V, \ I_S = 2.3 \ A$ (Note 2)		0.75	1.2	V
Drain-So s √ _{sD} tes: R _{θJA} is the su	urce Diode Characteristics Maximum Continuous Drain-Sourc Drain-Source Diode Forward	ce Diode Forward Current $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 2.3 \text{ A}$ (Note 2) t resistance where the case thermal reference he user's board design. en mounted b) R	_{өја} = 96 ^о с	0.75	1.2 drain tab.	A

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